

# Multi-Channel Silicon ESD Protector Overvoltage Protection Device

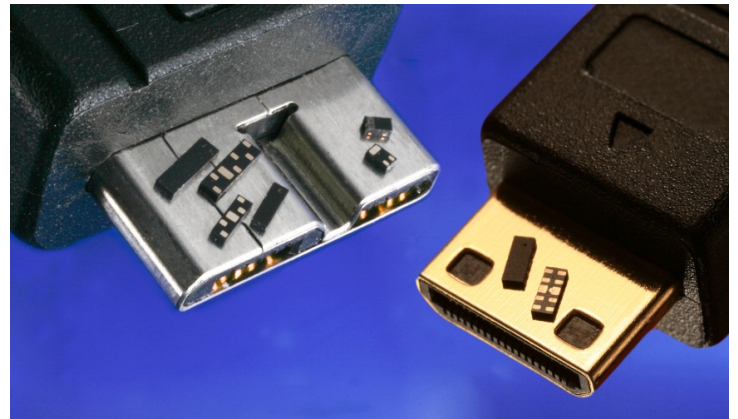
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308 Constitution Drive  
Menlo Park, CA 94025-1164  
www.circuitprotection.com

## Specification Status: RELEASED

### BENEFITS

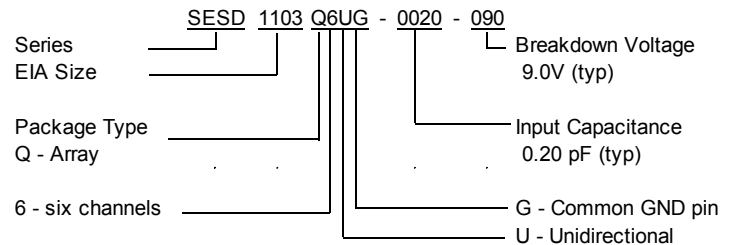
- Industry-leading lowest capacitance; provides lowest insertion loss for high speed data signals
- Industry's smallest footprint and lowest profile multi-channel ESD array helps to optimize board space
- Flow-through and single connection design helps routing PCB matched impedance high speed data lines
- Helps protect electronic circuits against damage from Electrostatic Discharge (ESD), surge and cable discharge events
- Assists equipment to pass IEC61000-4-2, level 4 testing



### FEATURES

- Low capacitance: 0.20 pF (200fF) (typ)
- Low leakage current: 25nA @ 5V (typ)
- Low clamping voltage: +9.20 / -0.80V (typ) @ (tp=8x20µs, Ipp=2A)
- ESD maximum rating per IEC61000-4-2 standard:
  - 20kV contact discharge
  - 20kV air discharge
- Surge: 2A (max) @ (tp=8x20µs) per IEC61000-4-5
- Small size and low profile: XDFN array packages 0.31mm height

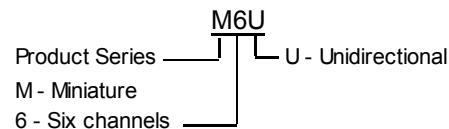
### PART NUMBERING



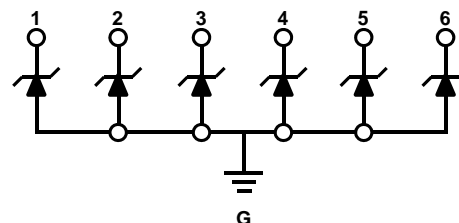
### APPLICATIONS

- Consumer, mobile and portable electronics
- Tablet PC and external storage with high speed interfaces
- Ultra-high speed data lines
- USB 3.0/2.0, HDMI 1.3/1.4, DisplayPort, Thunderbolt (Light Peak), V-by-One HS, and LVDS interfaces
- Applications requiring high ESD performance in small DFN packages

### PART MARKING



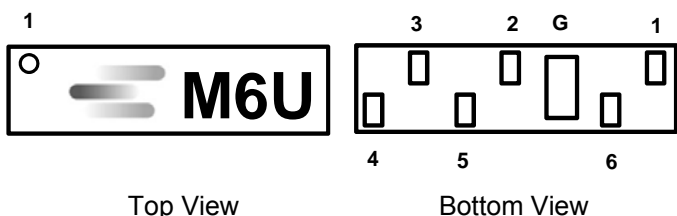
### SCHEMATIC AND PIN CONFIGURATION



### MATERIALS INFORMATION

RoHS Compliant
ELV Compliant
Halogen Free \* Lead Free

Directive 2000/53/EC Compliant
Directive 2002/95/EC Compliant
HF
Pb



\* Halogen Free refers to: Br≤900ppm, Cl≤900ppm, Br+Cl≤1500ppm  
SESD devices meet MSL-1 Requirements  
DFN case epoxy meets UL 94 V-0

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## DEVICE MAXIMUM RATING

| ESD Withstand <sup>(1)</sup><br>(IEC 61000-4-2, level 4) |          | Temperature    |              | Peak Current<br>(tp=8x20μs) |
|--|----------|----------------|--------------|-----------------------------|
| Contact (kV)   | Air (kV) | Operating (°C) | Storage (°C) | Ipp (A)                     |
| 20   | 20       | -55 to +125    | -55 to +150  | 2.0                         |

<sup>(1)</sup> 20kV @ 1 pulse; 10kV @ 100 pulses; 8kV @ 1,000 pulses (under IEC6100-4-2)

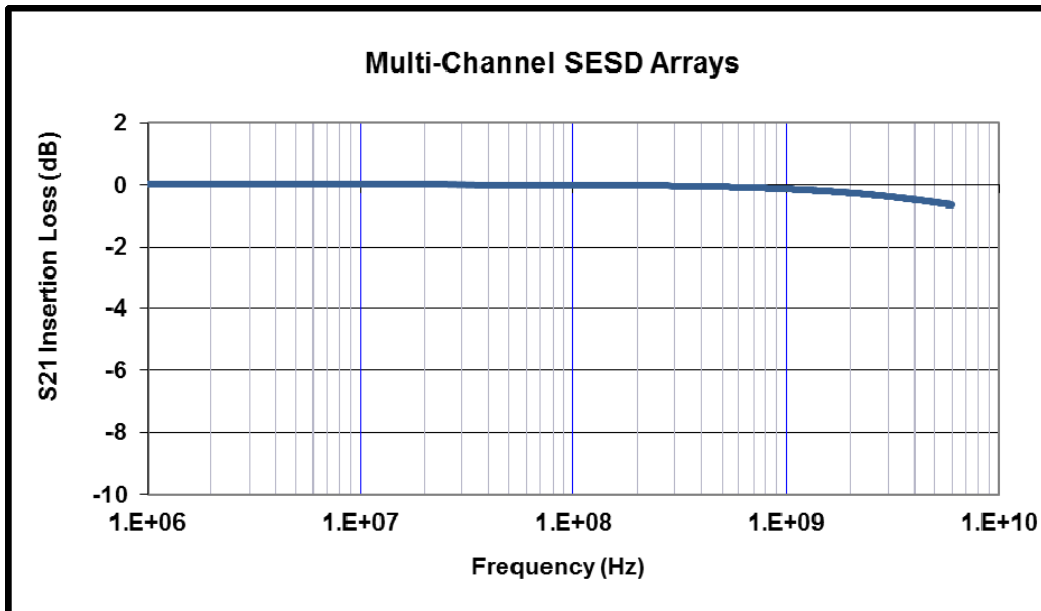
- Device maximum rating @ T = 25°C, unless otherwise specified
- Caution: Stress exceeding Device Maximum Ratings may damage the device  
 Prolonged exposure to stresses above the Recommended Operating Conditions may affect device reliability

## DEVICE ELECTRICAL CHARACTERISTICS

| Input Capacitance<br>@ V <sub>R</sub> = 0V, f = 3GHz, I/O to GND (pF) |         | Breakdown Voltage<br>V <sub>BR</sub> @ I <sub>T</sub> =1mA (V) | Reverse Working<br>Voltage (V) |       | Reverse Leakage Current<br>I <sub>L</sub> @ V <sub>RWM</sub> =5.0V (nA) |      | Clamping Voltage<br>V <sub>CL</sub> @ Ipp=2.0A (V) |
|---|---------|--|--------------------------------|-------|---|------|--|
| Typ   | Maximum | Typ  | Min                            | Max   | Typ   | Max  | Typ  |
| 0.20  | 0.22    | +9.00 / -0.80  | 0                              | +8.00 | 25.0  | 50.0 | +9.20 / -0.80                                      |

- All device electrical characteristics @ T = 25°C, unless otherwise specified

## FIGURE 1. INSERTION LOSS DIAGRAM



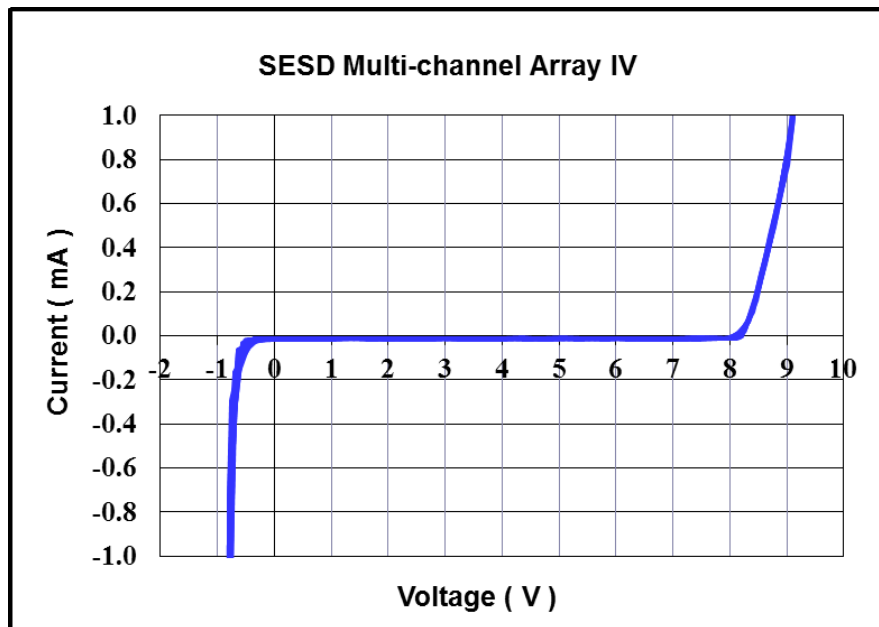
| Application             | Bit Rate (Gbps) | @Freq (GHz) | Ins. Loss (dB) |
|-------------------------|-----------------|-------------|----------------|
| HDMI 1.4 (1080P)        | 2.25            | 1.13        | -0.15          |
| DisplayPort             | 2.70            | 1.35        | -0.20          |
| HDMI 1.4 (4K / QuadHD)* | 3.40            | 1.70        | -0.23          |
| USB3.0                  | 5.00            | 2.50        | -0.29          |
| eSATA                   | 6.00            | 3.00        | -0.35          |
| Thunderbolt             | 10.0            | 5.00        | -0.50          |

\*HDMI 4K / QuadHD resolutions (4096 x 2160) ready

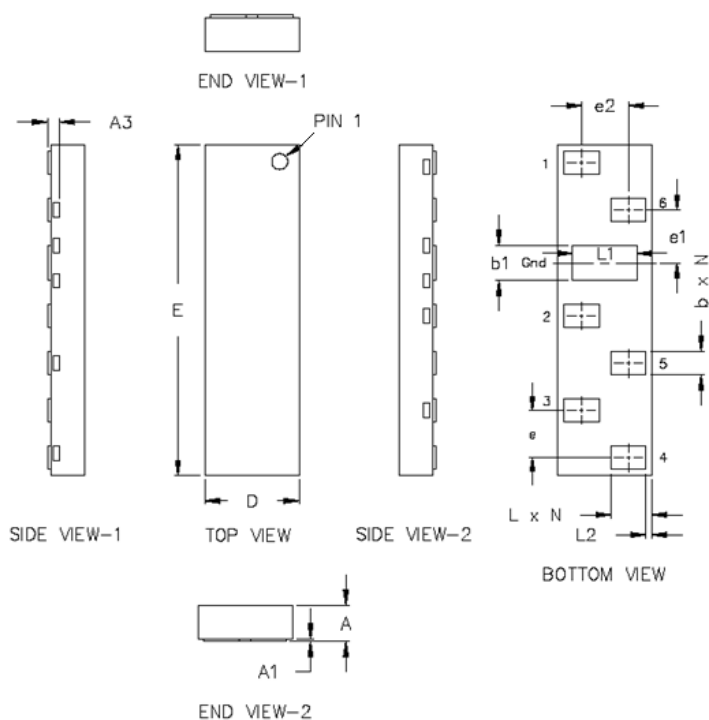
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**FIGURE 2. DEVICE IV CURVE**



**DEVICE DIMENSIONS**



| Dim | SESD1103Q6UG-0020-090 |      |      | Inches     |       |       |
|-----|-----------------------|------|------|------------|-------|-------|
|     | Min                   | Nom  | Max  | Min        | Nom   | Max   |
| A   | 0.30                  | 0.31 | 0.32 | 0.012      | 0.012 | 0.013 |
| A1  | 0.00                  | --   | 0.05 | 0          | --    | 0.002 |
| A3  | 0.10 ref              |      |      | 0.004 ref. |       |       |
| D   | 0.70                  | 0.80 | 0.90 | 0.027      | 0.031 | 0.035 |
| E   | 2.70                  | 2.80 | 2.90 | 0.106      | 0.110 | 0.114 |
| b   | 0.15                  | 0.20 | 0.25 | 0.006      | 0.008 | 0.010 |
| b1  | 0.25                  | 0.30 | 0.35 | 0.010      | 0.012 | 0.014 |
| L   | 0.30                  | 0.35 | 0.40 | 0.012      | 0.014 | 0.016 |
| L1  | 0.50                  | 0.55 | 0.60 | 0.019      | 0.021 | 0.023 |
| L2  | 0.05 BSC              |      |      | 0.002 BSC  |       |       |
| e   | 0.40 BSC              |      |      | 0.016 BSC  |       |       |
| e1  | 0.45 BSC              |      |      | 0.018 BSC  |       |       |
| e2  | 0.40 BSC              |      |      | 0.016 BSC  |       |       |
| N   | 6                     |      |      | 6          |       |       |

BSC – Basic Spacing between Centers

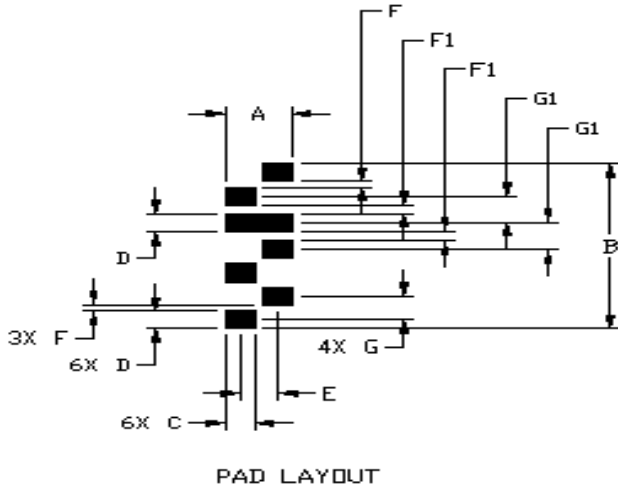
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## RECOMMENDED LANDING PATTERN:

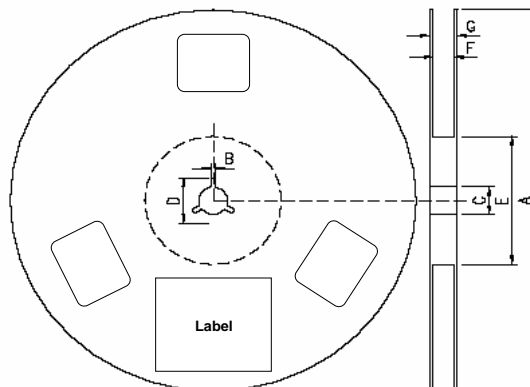


| SESD Landing Pad Layout<br>7 Pin 6-ch Miniature FT Array |             |           |
|--|-------------|-----------|
| Symbol   | Millimeters | Inches    |
| A  | 0.80        | 0.031     |
| B  | 2.80        | 0.110     |
| C  | 0.35        | 0.014     |
| D  | 0.30        | 0.012     |
| E  | 0.45        | 0.018     |
| F  | 0.10        | 0.004     |
| F1   | 0.15        | 0.006     |
| G  | 0.40 BSC    | 0.016 BSC |
| G1   | 0.40 BSC    | 0.016 BSC |

## PACKAGING

| Packaging             | Tape & Reel | Standard Box |
|-----------------------|-------------|--------------|
| SESD1103Q6UG-0020-090 | 5,000       | 25,000       |

## REEL DIMENSIONS



| Dimensions | A           | B            | C                 | D          | E          | F             | G          |
|------------|-------------|--------------|-------------------|------------|------------|---------------|------------|
| (mm)       | 180.0 ± 1.5 | 2.3. 0 ± 0.2 | 13.0 + 0.5 / -0.2 | 17.3 ± 0.2 | 60.5 ± 1.5 | 8.4 +1.5/-0.0 | 14.4 (max) |

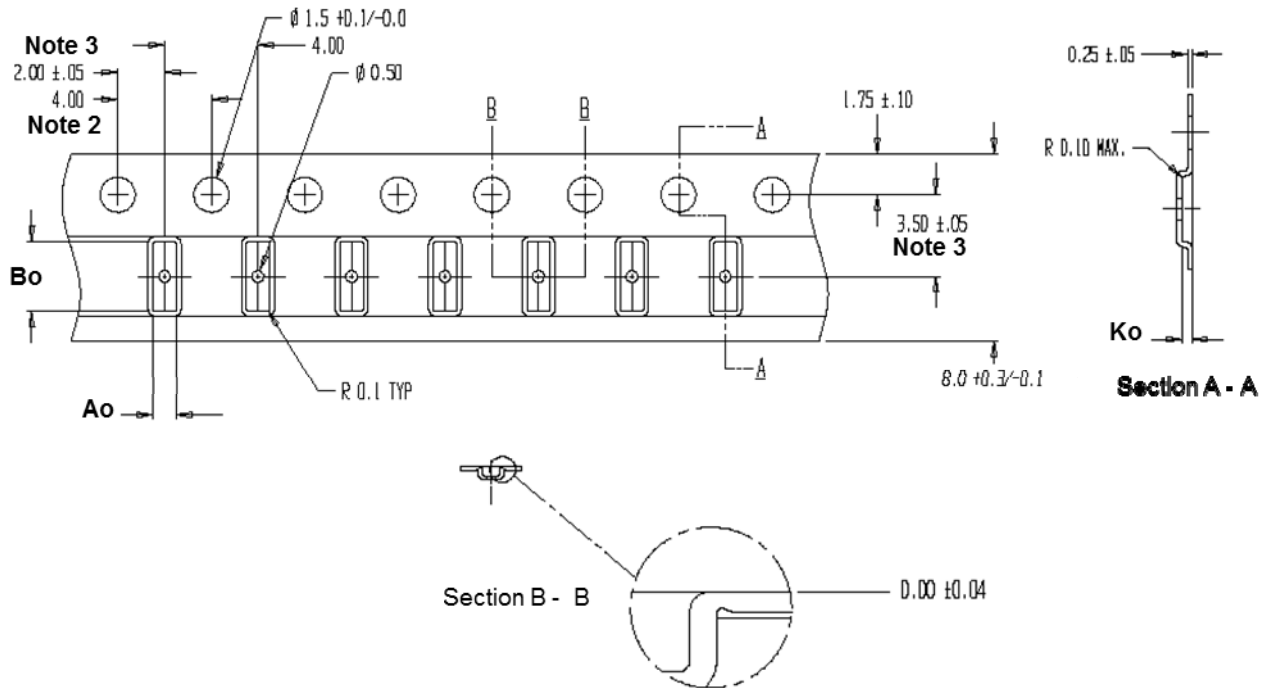
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## CARRIER TAPE DIMENSIONS



|    |             |
|----|-------------|
| Ao | 1.00 ± 0.05 |
| Bo | 3.00 ± 0.05 |
| Ko | 0.51 ± 0.05 |

Note 1. All dimensions in mm

Note 2. 10 sprocket hole pitch cumulative tolerance ± 0.2

Note 3. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole

Note 4. Ao and Bo are calculated on a plane at a distance "R" at the bottom of the pocket

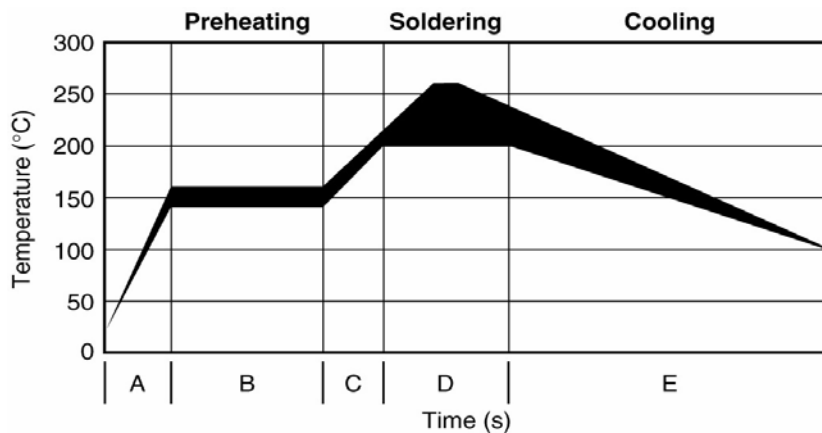
Note 5. Tolerances unless noted 1PL ± 0.20, 2PL ± 0.10

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### SOLDER REFLOW RECOMMENDATION

|   |                       |  |   |
|---|-----------------------|--|---|
| A | Temperature ramp up 1 | From ambient to Preheating temperature       | 30s to 60s                                      |
| B | Preheating            | 140°C - 160°C                                | 60s to 120s                                     |
| C | Temperature ramp up 2 | From Preheating to Main heating temperature  | 20s to 40s                                      |
| D | Main heating          | at 200°C<br>at 220°C<br>at 240°C<br>at 260°C | 60s ~ 70s<br>50s ~ 60s<br>30s ~ 40s<br>5s ~ 10s |
| E | Cooling               | From main heating temperature to 100°C       | 4°C/s (max)                                     |

### FIGURE 3. REFLOW PROFILE



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